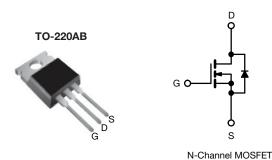
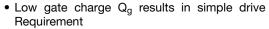


# **Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	600			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	1.2		
Q <sub>g</sub> max. (nC)	42			
Q <sub>gs</sub> (nC)	10			
Q <sub>gd</sub> (nC)	20			
Configuration	Single			

### **FEATURES**





Improved gate, avalanche and dynamic dV/dt ruggedness



- Fully characterized capacitance and avalanche voltage and current
- Effective Coss specified
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- High speed power switching

## **TYPICAL SMPS TOPOLOGIES**

· Single transistor forward

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFBC40APbF			
Lead (Pb)-free and halogen-free	IRFBC40APbF-BE3			

ABSOLUTE MAXIMUM RATINGS ( $T_C$	- 20 °O, am	1	-			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	600	V	
Gate-source voltage			$V_{GS}$	± 30	V	
Continuous drain current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$		6.2		
		T <sub>C</sub> = 100 °C	I <sub>D</sub>	3.9	Α	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	25		
Linear derating factor				1.0	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	570	mJ	
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	6.2	Α	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Maximum power dissipation	$T_C = 2$	25 °C	P <sub>D</sub>	125	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	6.0	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300	7	
Mounting torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Starting  $T_J$  = 25 °C, L = 29.6 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 6.2 A (see fig. 12)
- c.  $I_{SD} \le 6.2$  A,  $dI/dt \le 80$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_{J} \le 150$  °C
- d. 1.6 mm from case



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# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62		
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	1.0		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•					•
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.66	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> :	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		-	4.0	V
Gate-source leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V		-	± 100	nA
		V <sub>DS</sub> :	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	25	1
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 3.7 A <sup>b</sup>	-	-	1.2	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 3.7 A		-	-	S
Dynamic							•
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$	-	1036	-	
Output capacitance	C <sub>oss</sub>		$V_{GS} = 0 V$ , $V_{DS} = 25 V$ ,		136	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	7.0	-	pF
Output capacitance	C <sub>oss</sub>		V <sub>DS</sub> = 1.0 V, f = 1.0 MHz	-	1487	-	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 480 V, f = 1.0 MHz	-	36	-	
Effective output capacitance	C <sub>oss</sub> eff.	1	V <sub>DS</sub> = 0 V to 480 V <sup>c</sup>	-	48	-	
Total gate charge	Qg			-	-	42	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 6.2 \text{ A}, V_{DS} = 480 \text{ V}$ see fig. 6 and 13 b		-	10	nC
Gate-drain charge	Q <sub>gd</sub>		See lig. 0 and 15	-	-	20	1
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD} = 300 \text{ V}, I_D = 6.2 \text{ A}$ $R_g = 9.1 \Omega, R_D = 47 \Omega,$ see fig. 10 b		-	13	-	ns
Rise time	t <sub>r</sub>			-	23	-	
Turn-off delay time	t <sub>d(off)</sub>			-	31	-	
Fall time	t <sub>f</sub>			-	18	-	
Gate input resistance	Rg	f = 1 MHz, open drain		0.6	-	3.9	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.2	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	25	A
Body diode voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 6.2  \text{A},  V_{GS} = 0  \text{V}^{ \text{b}}$		-	-	1.5	V
Body diode reverse recovery time	t <sub>rr</sub>	$T_{\rm J} = 25~{\rm ^{\circ}C}, \ I_{\rm F} = 6.2~{\rm A}, \ {\rm dI/dt} = 100~{\rm A/\mu s}^{\rm b}$		-	431	647	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	1.8	2.8	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated				v L <sub>s</sub> and	L <sub>D</sub> )

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq 300 \, \mu s$ ; duty cycle  $\leq 2 \, \%$
- c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

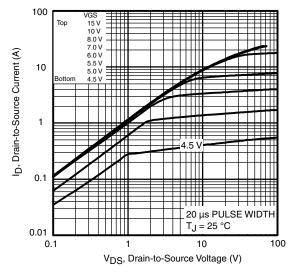


Fig. 1 - Typical Output Characteristics

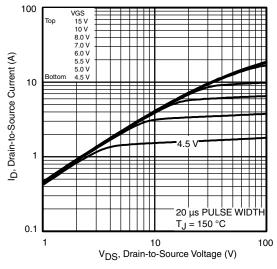


Fig. 2 - Typical Output Characteristics

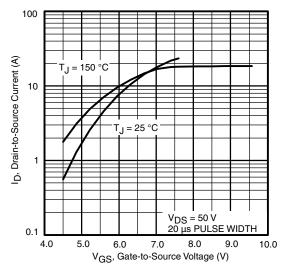


Fig. 3 - Typical Transfer Characteristics

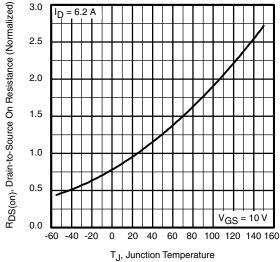


Fig. 4 - Normalized On-Resistance vs. Temperature



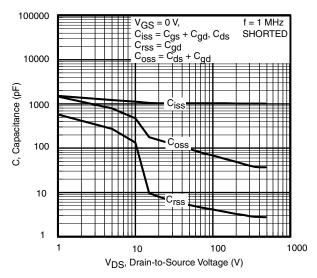


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

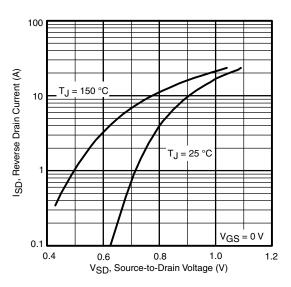


Fig. 7 - Typical Source-Drain Diode Forward Voltage

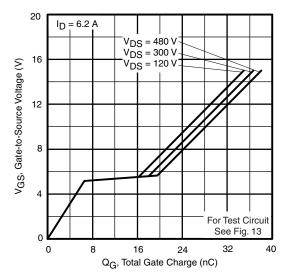


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

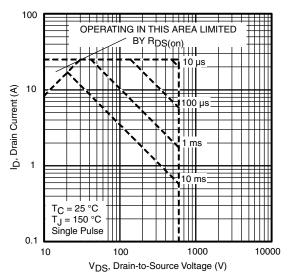


Fig. 8 - Maximum Safe Operating Area



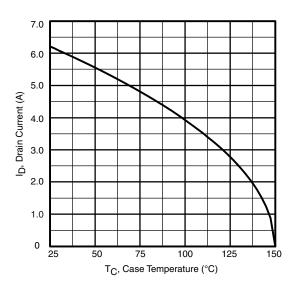


Fig. 9 - Maximum Drain Current vs. Case Temperature

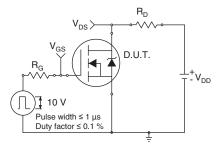


Fig. 10a - Switching Time Test Circuit

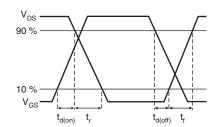


Fig. 10b - Switching Time Waveforms

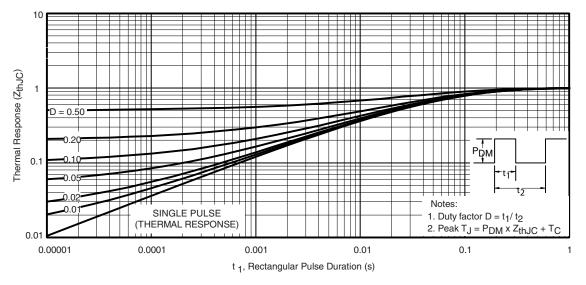


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

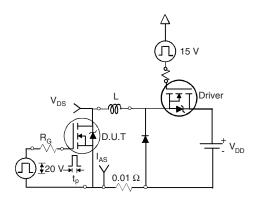


Fig. 12a - Unclamped Inductive Test Circuit

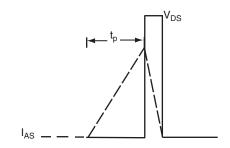


Fig. 12b - Unclamped Inductive Waveforms

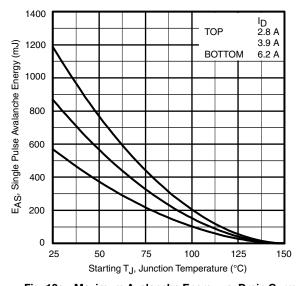


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

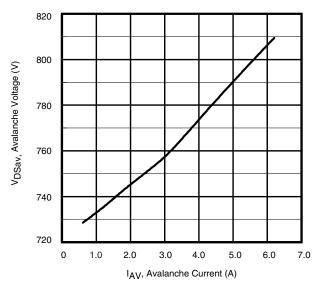


Fig. 12d - Typical Drain-to-Source Voltage vs.
Avalanche Current

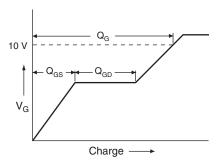


Fig. 13a - Basic Gate Charge Waveform

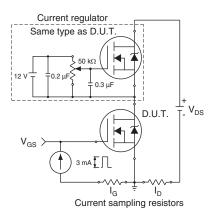
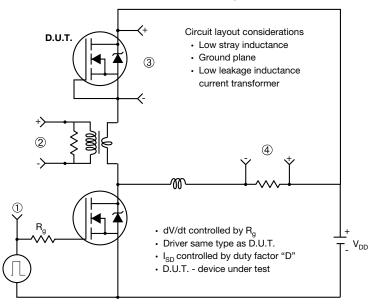


Fig. 13b - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



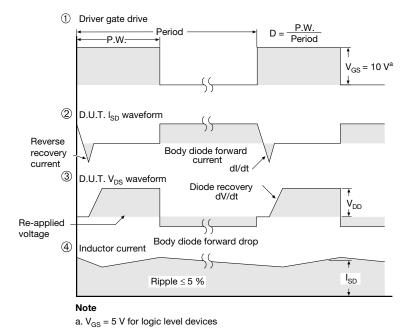


Fig. 14 - For N-Channel

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